Drawing No.: RPCH-K-HTS-0002 /2

Date: 2024.12.13

Data sheet

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR

TYPE AND HIGH POWER · ANTI SURGE

Style: RPCH10,16,20,32,35

AEC-Q200 qualified

RoHS COMPLIANCE ITEM Halogen and Antimony Free

Note: •Stock conditions

Temperature: $+5^{\circ}\text{C} \sim +35^{\circ}\text{C}$ Relative humidity: $25\% \sim 75\%$

The period of guarantee: Within 2 year from shipment by the company.

Solderability shall be satisfied.

- Product specification contained in this data sheet are subject to change at any time without notice
- If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

KAMAYA OHM

RPCH-K-HTS-0002 Drawing No:

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND

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1. Scope

1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type & high power · anti surge, style of RPCH10,16,20,32,35.

1.2 Applicable documents

JIS C 5201-1: 2011, IEC60115-1: 2008, AEC-Q200 Rev.D

2. Classification

Type designation shall be the following form.

(Example)

RPCH	32	K	123	J	TP
1	2	3	4	5	6
Style	9				

1 Fixed thick film chip resistors; rectangular type & & high power · anti surge

Style

- 2 Rated dissipation and / or dimension
- 3 Temperature coefficient of resistance

K	±100×10 ⁻⁶ / °C
–(Dash)	Standard

4 Rated resistance

123	E24 Series, 3 digit,	Ex. 123-> 12kΩ,
1000	E96 Series, 4 digit,	Ex. 1000>100Ω
		1022> 10.2kΩ

5 Tolerance on rated resistance

D	±0.5%
F	±1%
J	±5%

6 Packaging form

TH	Donor toning	
TP	Paper taping	
TE	Embossed taping	

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3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1

Style	Rated dissipation (W)		ure coefficient of nce (10°/°C)	Rated resistance range (Ω)	Preferred number series for resistors	Tolerance on rated resistance
			±100	10~1M	E24, 96	D(±0.5%)
RPCH10	0.2	Standard	±200	1.0~9.76	∠24, 90	F(±1%)
RPCHIU	0.2	K	±100	10~1M	F04	1/150/)
		Standard	±200	1.0~9.1	E24	J(±5%)
		K	±100	10~1M	E24, 96	D(±0.5%),
RPCH16	0.33	Standard	±200	1.0~9.76	⊑ 24, 90	F(±1%)
RPCHIO	0.33	K	±100	10~1M	E24	1/+50/)
		Standard	±200	1.0~9.1	E2 4	J(±5%)
		K	±100	10~1M	E24, 96	D(±0.5%),
RPCH20	0.5	Standard	±200	1.0~9.76	Ľ24, 90	F(±1%)
TAFCHZO	0.5	K	±100	10~1M	E24	J(±5%)
		Standard	±200	1.0~9.1	LZ4	J(±3 /0)
		K	±100	10~1M	E24, 96	D(±0.5%),
RPCH32	0.66	Standard	±200	1.0~9.76	L24, 90	F(±1%)
TAF OI 152	0.00	K	±100	10~1M	E24	J(±5%)
		Standard	±200	1.0~9.1	⊏24	J(±370)
	0.75	K	±100	10~1M	E24, 96	D(±0.5%),
RPCH35		Standard	±200	1.0~9.76	⊏24, 90	F(±1%)
INF OF ISS		K	±100	10~1M	E24	I(±5%)
		Standard	±200	1.0~9.1	L2 4	J(±5%)

Style	Limiting element voltage (V)	Insulation voltage	Category temperature range(°C)
-	(V)	(V)	range(C)
RPCH10	50	100	
RPCH16	150	150	
RPCH20			<i>–</i> 55∼+155
RPCH32	200	500	
RPCH35			

3.2 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

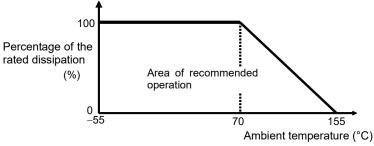


Figure-1 Derating curve

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3.3 Rated voltage

d.c.or a.c.r.m.s.voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

E: Rated voltage (V)

P: Rated dissipation (W)

R: Rated resistance (Ω)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	mbol Packaging form		Standard packaging quantity / units	Application
TH	Departaning	8mm width, 2mm pitches	10,000 pcs.	RPCH10
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RPCH16,20,32
TE	Embossed taping	8mm width, 4mm pitches	4,000 pcs.	RPCH35

5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

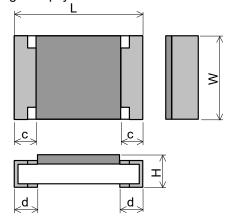


Figure-2

Table–3 Unit: mm

Style	L	W	Н	С	d
RPCH10	1.0±0.05	0.5±0.05	0.35±0.05	0.2±0.15	0.25 ^{+0.05}
RPCH16	1.6±0.1	0.8 +0.15 -0.05	0.45±0.10	0.3±0.2	0.3±0.1
RPCH20	2.0±0.1	1.25±0.10	0.55±0.10	0.3±0.2	0.4±0.2
RPCH32	3.1±0.1	1.6±0.15	0.55±0.10	0.3±0.2	0.5±0.25
RPCH35	3.1±0.15	2.5±0.15	0.55±0.15	0.3±0.2	0.5±0.25

5.2 Net weight (Reference)

Style	Net weight(mg)
RPCH10	0.6
RPCH16	2
RPCH20	5
RPCH32	9
RPCH35	16



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6. Marking

The Rated resistance of RPCH10 is not be marked.

RPCH16.20.32.35

The Rated resistance shall be marked in 3 digits (E24) or 4 digits (E96) and marked on over coat side.

• E24 series: 3 digits, E96 series: 4 digits

In case of the resistance value that E96 overlaps with E24, It is marked by either.

• The Rated resistance of RPCH16 should not be marked in 4 digits(E96)

Marking example	Contents	Application
123	12×10 ³ $[\Omega] \rightarrow$ 12 $[k\Omega]$	E24(RPCH16,20,32,35)
2R2	2.2 [Ω]	E24(RPCH 16,20,32,35)
5623	$562 \times 10^3 \ [\Omega] \rightarrow 562 \ [k\Omega]$	E96(RPCH 20,32,35)
12R7	12.7 [Ω]	E96(RPCH 20,32,35)

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7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1: 2011.

7.2 The performance shall be satisfied in Table-4.

Table-4(1)

	- · ·	1able-4(1)	D (
No.	Test items	Condition of test	Performance requirements
1	High temperature exposure	MIL-STD-202 Method 108	Δ R/R: Within \pm (2%+0.1 Ω)
	AEC Q200 - No.3	Ambient temperature:155±2°C,	
		Condition: Without load,	No visible damage
		Duration: $1000 \frac{48}{0}$ h	
		Interval measurements: 250 h and 500 h	
2	Temperature cycling	JESD22 Method JA-104	Δ R/R: Within \pm (1%+0.05 Ω)
	AEC Q200 - No.4	Temperature: -55±3°C / 125±2°C,	
		Dwell time: 30min maximum at each temp.	No visible damage
		Transition time: 1 min. max.	
		Number of cycles: 1000 cycles.	
_	D: 1	Interval measurements: 250 cy and 500 cy	
3	Bias humidity	MIL-STD-202 Method 103	Δ R/R: Within \pm (2%+0.1 Ω)
	AEC Q200 – No.7	Condition: 85°C & 85% R.H.	NI - della della della
		Test power: 10% of rated power shall be	No visible damage
		applied for continuously.	
		Duration: 1,000 ⁺⁴⁸ ₀ h	
		Interval measurements: 250 h and 500 h	
4	Operational life	MIL-STD-202 Method 108	Δ R/R: Within ±(2%+0.1 Ω)
	AEC Q200 – No.8	Ambient temperature: 125±2°C	
		The applied voltage shall be the voltage to be	No visible damage
		calculated at 35% of rated dissipation or the	
		limiting element voltage whichever is the	
		smaller.	
		Condition: The voltage shall be applied for continuously.	
		Duration: $1000 \stackrel{+48}{0} h$	
		Interval measurements: 250 h and 500 h	
5	External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking
	AEC Q200 – No.9		and workmanship.
6	Dimensions	JESD22 Method JB-100	As in Table–3
	AEC Q200 – No.10		
7	Resistance to Solvents	MIL-STD-202 Method 215	Δ R/R: Within \pm (1%+0.05 Ω)
	AEC Q200 – No.12	Solvent: 2-propanol at 25°C	
		Immersion time: 3 min	No visible damage
		Brush: 10 times brushing	
	101	Immersion and brush cycle: 3cycle	
8	Mechanical Shock	MIL-STD-202 Method 213	Δ R/R: Within \pm (0.5%+0.05 Ω)
	AEC Q200 – No.13	Waveform: half sine,	
		Peak value100G,	No visible damage
		Normal duration 6ms	
		Condition: XX'YY'ZZ', 18times total	

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Table-4(2)

	T	Table 4(2)		
No	Test items	Condition of test	Performance requirements	
9	Vibration AEC Q200 – No.14	MIL-STD-202 Method 204 Peak acceleration and Sweep time: 5 g's for	Δ R/R: Within $\pm (0.5\% + 0.05\Omega)$	
	AEC Q200 - No. 14	20 min , Frequency 10Hz to 2000Hz,	No visible damage	
		Condition: 12 cycles each of 3 orientations	9	
10	Resistance to soldering heat	MIL-STD-202 Method 210	Δ R/R: Within \pm (0.5%+0.05 Ω)	
	AEC Q200 - No.15	Solder bath temp: 260±5°C		
		Immersed time: 10±1s	No visible damage	
11	ESD test	AEC-Q200-002	Δ R/R: Within \pm (1%+0.05 Ω)	
	AEC Q200 – No.17	Human body model, 2 Kohm, 150 pF, Test voltage: RPCH20,32,35: 3000V	No visible damage	
		RPCH16: 2000V	•	
		RPCH10: 800V		
12	Solderability	J-STD-002	The surface of terminal immersed	
	AEC Q200 - No.18	a) Bake the sample for 155 °C dwell time 4h /	shall be min. of 95% covered with a	
		solder dipping 235°C/5s.	new coating of solder.	
		Solder: Sn96.5-Ag3-Cu0.5		
		b) Category 3, Solder dipping 215°C/5s. Solder: Sn63Pb37		
		c) Category 3, Solder dipping 260°C/7s.		
13	Electrical Characterization	1. D.C. Resistance	1. The resistance value shall	
	AEC Q200 - No.19	Temperature Coefficient of Resistance	correspond with the rated	
		-55 °C / +20°C	resistance taking into account the	
		+20 °C / +155°C	specified tolerance.	
			2. As in Table–1	
14	Flammability	UL-94	V-0 or V-1 are acceptable	
	AEC Q200 – No.20			
15	Bending strength	AEC-Q200-005	Δ R/R: Within \pm (0.5%+0.05 Ω)	
	AEC Q200 – No.21	Bending value2mm		
46		Holding time: 60sec.	No visible damage	
16	Adhesion	AEC-Q200-006	Δ R/R: Within \pm (0.5%+0.05 Ω)	
	AEC Q200 - No.22	Pressurizing force: RPCH20,32,35: 17.7N	No visible demosts	
		RPCH10,16: 10N Test time: 60±1s.	No visible damage	
17	Flame retardance	AEC-Q200-001	The following FAILURE CRITERIA	
''	AEC Q200 – No.24	Test conditions: 9VDC to 32VDC Each 1h	does not occur.	
	, 120 0200 140.21	This test applies to rated voltages of 32V and	FAILURE CRITERIA	
		above.	- Electrically open	
			a) A flame over 3.0 seconds duration	
			b) An explosion	
			c) A temperature above 350°C	
			sustained for over 10 s	

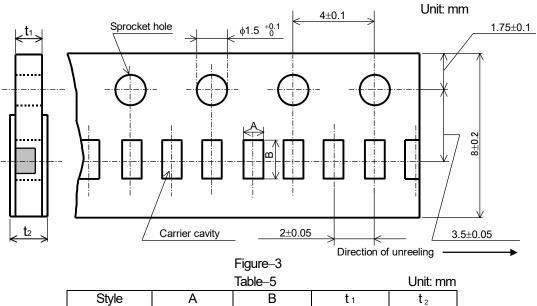
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8. Taping

- 8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 8.2 Taping dimensions
- 8.2.1 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.



 $1.15^{+0.05}_{-0.10}$

В t₁

 0.4 ± 0.05

0.5max.

8.2.2 Taping dimensions shall be in accordance with Figure-4 and Table-6.

 $0.65^{+0.05}_{-0.10}$

RPCH10

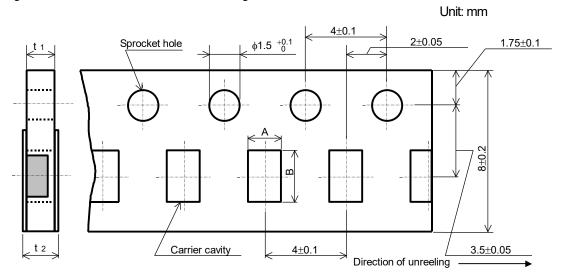


Figure-4

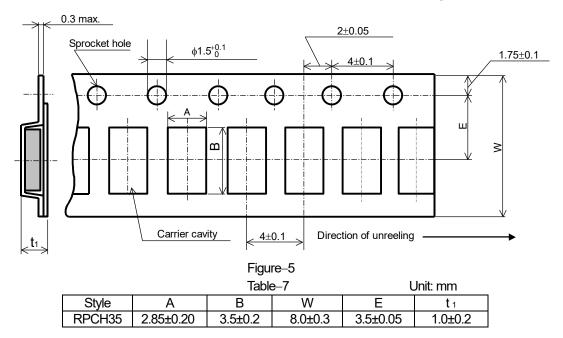
	Unit: mm			
Style	A	ble–6 B	t ₁	t ₂
RPCH16	1.15±0.15	1.9±0.2	0.6±0.1	0.8max.
RPCH20	1.65±0.15	2.5±0.2	0.8±0.1	1.0max.
RPCH32	2.00±0.15	3.6±0.2	0.8±0.1	1.0max.

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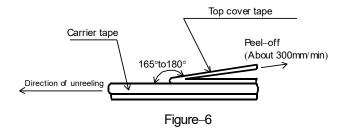
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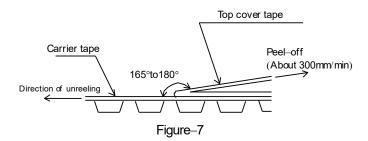
8.2.3 Embossed taping dimensions shall be in accordance with Figure-5 and Table-7.

Unit: mm



- 1). The cover tapes shall not cover the sprocket holes.
- Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RPCH10,16,20,32:Figure-6,RPCH35:Figure-7.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing. The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.





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Unit: mm

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8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-8 and Table-8. Plastic reel (Based on EIAJ ET-7200C) Unit: mm

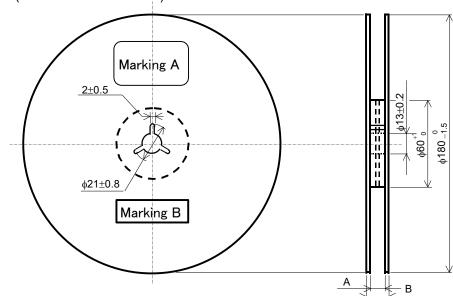
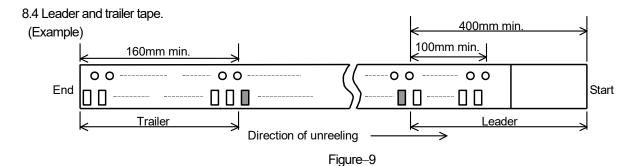


Figure-8

Table–8							
Style	Α	В	Note				
RPCH10,16,20,32,35	9 +1.0	11.4±1.0	Injection molding				
147 01110, 10,20,32,33		13±1.0	Vacuum forming				

Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.



9. Marking on package

The label of a minimum package shall be legibly marked with follows.

9.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

- (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others
- 9.2 Marking B (KAMAYA control label)